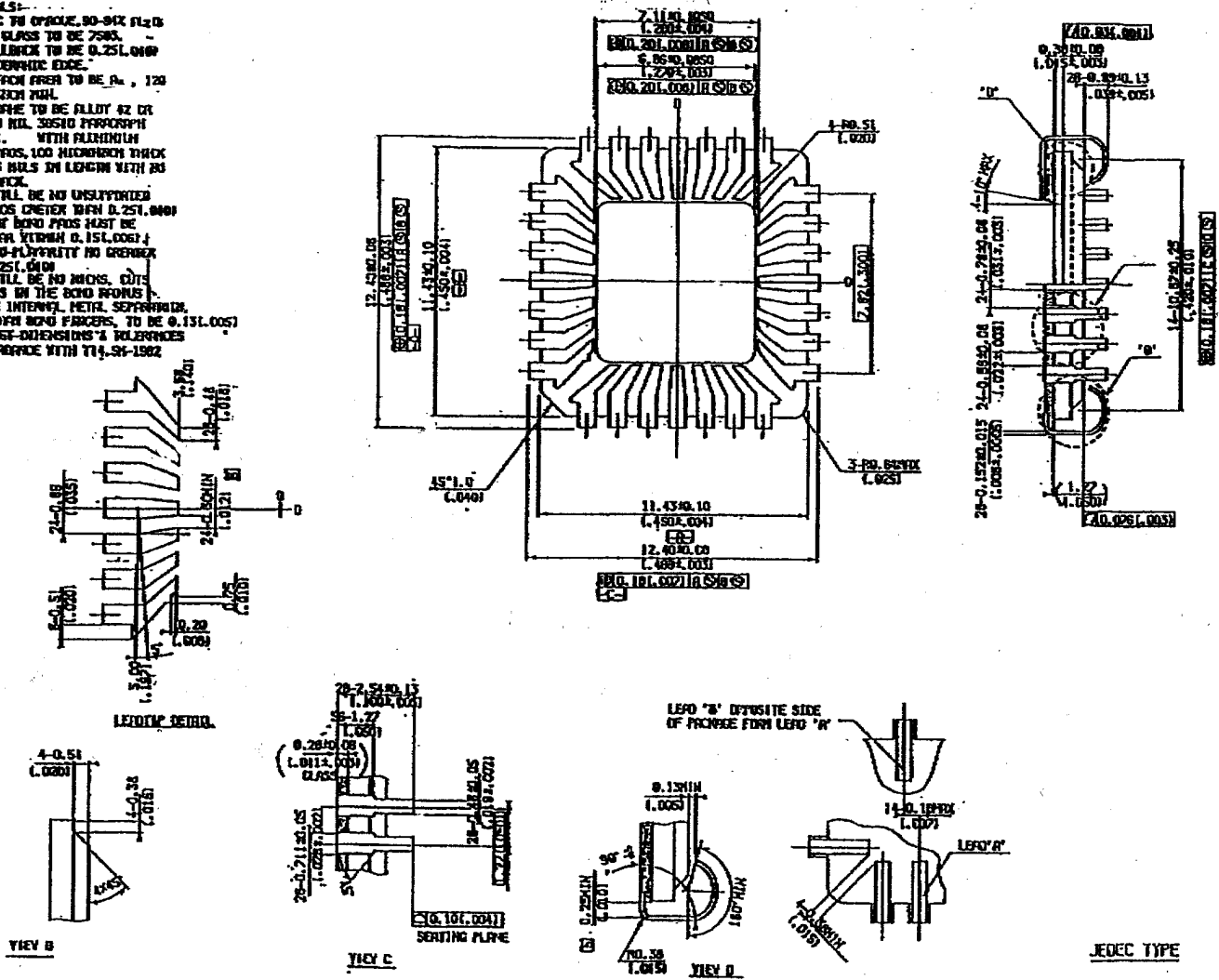


# SSM P/N CQJ02804

**NOTES**

1. MATERIALS:  
CERAMIC TO SPEC. 90-94K R12-D  
SOLDER GLASS TO BE 7580.  
MAX PULLBACK TO BE 0.251.000  
FROM CERAMIC EDGE.  
DIE MOUNT AREA TO BE  $\phi$  1.20  
HIGHER THAN  
LEAD FRAME TO BE ALLOY 42 OR  
TYPE B RAL 35510 PARAGRAPH  
3.5.6.1. WITH ALUMINUM  
BOND PROS. 100 HIGHER THAN  
R10 35 HILS IN LENGTH WITH 80  
FULL DICK.
2. THERE WILL BE NO UNSUPPORTED  
BOND PROS EXCEPT WITH 0.251.000
3. POLYMER BOND PROS MUST BE  
CO-PLANAR WITHIN 0.151.000  
TOTAL CO-PLANARITY NO GREATER  
THAN 0.251.000
4. THERE WILL BE NO MISC. CUTS  
OR GLASS IN THE BOND PROS  
BETWEEN INTERNAL METAL SEPARATORS  
WHICH WITH BOND FRAMES, TO BE 0.151.000
5. DIMENSIONAL TOLERANCES & TOLERANCES  
IN ACCORDANCE WITH T11.91-1982



NAME ZEILD DUNG CERAMIC J (450-270)	TOLERANCES UNLESS OTHERWISE SPECIFIED	GRADE	CHECKED
DESIGN R110000		Approved	Approved
DATE 10/31		DATE	JUL 10 '88
KYOCERA CORPORATION		STATION JAPAN	DC-028232-J

